

07-12-2001



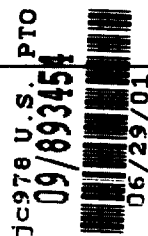
1 COVER SHEET
ONLY

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ATTN. BOX ASSIGNMENTS



1. Name of conveying party(ies):

1. Kazuyuki HIGASHI
2. Tamao TAKASE
3. Hideki SHIBATA

06/29/01

2. Name and address of receiving party(ies):

Name: KABUSHIKI KAISHA TOSHIBA

Internal Address:

Street Address: 72 Horikawa-cho, Saiwai-ku,
Kawasaki-shi, JAPAN

City:

State:

Zip Code:

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name

Other

☐

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Additional name(s) & Address(es) attached?

☐ Yes ☒ No

Execution Date: June 22, 2001

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: June 22, 2001

A. Patent Application Number(s):

09/893454

B. Patent Number(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT
& DUNNER, L.L.P.

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40
☒

Enclosed (Please charge deficiency to deposit account)
☐

Authorized to be charged to deposit account

Street Address: 1300 I Street, N.W.

City: Washington

State: DC Zip: 20005-3315

8. Deposit account number: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Richard V. Burgujian

Signature

June 29, 2001

Date

Total number of pages including cover sheet, attachments and documents: 3

A S S I G N M E N T

In consideration of value received, I, having a mailing address at
c/o Intellectual Property Division, KABUSHIKI KAISHA TOSHIBA, 1-1 Shibaura
1-chome, Minato-ku, Tokyo 105-8001, Japan and a residence as stated below
next to my name, the sole inventor (if only one name is listed below)
or a joint inventor (if plural inventors are listed below) of an
invention described in an application for United States patent entitled:

SEMICONDUCTOR DEVICE MANUFACTURING METHOD INCLUDING FORMING STEP OF SOI
STRUCTURE AND SEMICONDUCTOR DEVICE HAVING SOI STRUCTURE

said application having been filed on
and assigned Application No. ;
sell and assign to
KABUSHIKI KAISHA TOSHIBA
a corporation of Japan, having a business address at
72 Horikawa-cho, Saiwai-ku, Kawasaki-shi, Japan

its successors, assigns or nominees, hereinafter referred to as
"Assignee", my entire right, title and interest in and to said invention
as disclosed, shown and described in said application for United States
patent: (check one)

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☐ executed separately herefrom;

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Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P.,
1300 I Street, N.W., Washington, D.C., 20005-3315

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01S0371

Inventor: (Signature)

Date

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